Thin Flim Chip Inductors

multicomp PRO





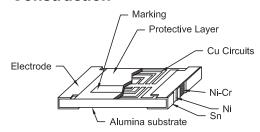
Features

- · Photolithographic single layer ceramic chip
- · High SRF, excellent Q, superior temperature stability
- Tight tolerance of± 1% or ± 0.1nH
- · Self resonant frequency controlled within 10%
- · Stable inductance in high frequency circuit
- · Highly stable design for critical needs

Application

- Cellular Phone, Pagers and GPS Products
- VCO, TCXO, Circuit an dRF Transceiver Module
- · Wireless LAN Bluetooth module, Communication Appliances

Construction



Item		Specification	Test Method	
1	Bending Test	As SPEC.	JIS-C-5202-6. 1.4 Bending Amplitude 3mm for 1 0 seconds	
2	Dielectric Withstand Voltage	>100V	MIL-STD-202F Method 301. Apply 100VA (rms) for 1minute.	
3	Insulation Resistance	>1000Mn	MIL-STD-202F Method 302 Apply 100V DC for 1 minute.	
4	Resistance to Soldering Heat	ΔL<10%	MIL-STD-202F Method 210E 260±5°C 10±1seconds	
5	High Temperature Exposure	ΔL<10%	JIS-C-5202-7.2 85±2°C, 1000 +48/-0 hours	
6	Moisture Resistance	ΔL<10%	MIL-STD-202F Method 103B 40+2°C, 90-95%RH 1000 +48/-0 hours	
7	Low Temperature Storage	ΔL<10%	JIS-C-5202-7.1 -40±3°C. 1 000 +48/-0 hours	
8	Temperature Cycle	ΔL<10%	JIS-C-5202-7.4 -40/RT/85/RT 1 0 cvcles	
9	Solderability	95% min coverage	MIL-STD-202F Method 208H 245°C +soc 3+0.5(sec)	

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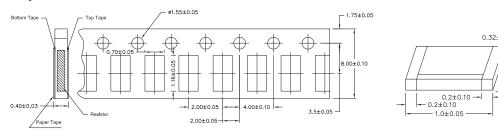


Specification Table

Part Number	Package/ Case	Q Factor	Test Frequency
MCFT000003	0402	Q Factor:13	500MHz
MCFT000004			
MCFT000008			
MCFT000009			

Part Number	Inductance	Inductance Tolerance	DC Resistance Max	DC Current Rating	Self Resonant Frequency
MCFT000003	3.3nH	±0.1nH	0.45ohm	380mA	6GHz
MCFT000004	4.7nH	±0.1nH	0.65ohm	320mA	5GHz
MCFT000008	15nH	±1%	1.75ohm	130mA	3GHz
MCFT000009	22nH	±1%	2.65ohm	90mA	2GHz

Tape Dimension



Dimensions: Millimetres

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